SGM8262-2 High Speed, Ultra-Low Noise, Rail-to-Rail Output, High Output Current Amplifier

GENERAL DESCRIPTION

The SGM8262-2 is a dual, low noise, high speed operational amplifier with voltage feedback function. The output swing is rail-to-rail with heavy loads. This maximizes the dynamic range and offers high linearity.

The SGM8262-2 features $3.5 \text{nV}/\sqrt{\text{Hz}}$ low voltage noise at 100 kHz with ultra-low distortion. It also has 22 MHz wide bandwidth at -3dB and $33 \text{V}/\mu\text{s}$ high slew rate. The device is unity-gain stable and has high output drive capability.

The SGM8262-2 is available in Green SOIC-8 and TDFN-3×3-8BL packages. It operates over an ambient temperature range of -40°C to +85°C.

FEATURES

• Ultra-Low Noise:

Voltage Noise: $3.5 \text{nV}/\sqrt{\text{Hz}}$ at 100kHz Current Noise: $4 \text{pA}/\sqrt{\text{Hz}}$ at 100kHz

• High Speed:

-3dB Bandwidth: 22MHz (G = +1) Slew Rate: 33V/ μ s (R_{LOAD} = 32 Ω)

• Unity-Gain Stable

High Output Current with Excellent Linearity: 310mA

• High Open-Loop Gain: 110dB

• Rail-to-Rail Output

Support Single or Dual Power Supplies:
 4.5V to 36V or ±2.25V to ±18V

• -40°C to +85°C Operating Temperature Range

 Available in Green SOIC-8 and TDFN-3×3-8BL Packages

APPLICATIONS

Audio Processing
General-Purpose AC Equipment
Twisted-Pair Wiring Drivers

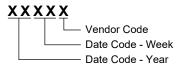


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE SPECIFIED ORDERING NUMBER RANGE		PACKAGE MARKING	PACKING OPTION	
SGM8262-2	SOIC-8	-40°C to +85°C	SGM8262-2YS8G/TR	SGM 82622YS8 XXXXX	Tape and Reel, 2500
3GIVIO202-2	TDFN-3×3-8BL	-40°C to +85°C	SGM8262-2YTDD8G/TR	SGM 82622DD XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage40V
Input Voltage Range (- V_S) - 0.3V to (+ V_S) + 0.3V
Input Current (All pins except power supply pins)±10mA
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD Susceptibility
HBM8000V
MM400V
CDM1000V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range-40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

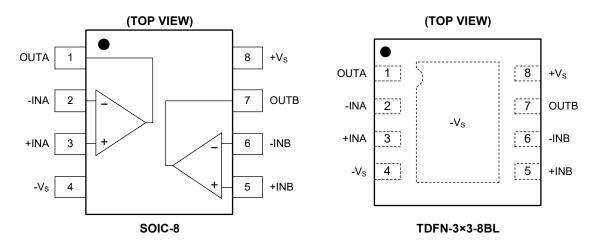
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



NOTE: For TDFN-3×3-8BL package, connect thermal die pad to -V_S. Connect it to -V_S plane to maximize thermal performance.

ELECTRICAL CHARACTERISTICS

 $\text{(At $T_A = +25^{\circ}$C, $V_S = 4.5$V to 36V or $V_S = \pm 2.25$V to ± 18V, $G = +1$, $R_{LOAD} = 32\Omega$, $V_{CM} = V_{OUT} = V_S/2$, unless otherwise noted.)}^{(1)}$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
DC Performance						
			±100	±500	.,	
Input Offset Voltage (Vos)	-40°C to +85°C			±610	μV	
Input Offset Voltage Match			±100	±700	μV	
Input Offset Voltage Drift (ΔV _{OS} /ΔT)			0.5		μV/°C	
1 (5: 0 (4))	$V_{CM} = V_S/2$		±40	±300	π Λ	
Input Bias Current (I _B)	-40°C to +85°C			±370	nA	
Input Offset Current (I _{OS})	$V_{CM} = V_S/2$		±10	±120	nA	
	$V_{OUT} = \pm 1V, V_{S} = \pm 2.5V \text{ or } 5V$	109	115			
Open-Loop Voltage Gain (A _{OL})	V _{OUT} = ±2V, V _S = ±5V or 10V	106	115		dB	
	$V_{OUT} = \pm 3V$, $V_{S} = \pm 18V$ or 36V	95	110			
Input Characteristics				•	•	
D	V _S = ±2.25V or 4.5V		38 ∥ 20			
Differential Input Impedance	V _S = ±18V or 36V		45 ∥ 15		kΩ II pF	
	V _S = ±2.25V or 4.5V		4 6			
Common Mode Input Impedance	V _S = ±18V or 36V		20 ∥ 5		GΩ ∥ pF	
Input Common Mode Voltage Range (V _{CM})		(-V _S) + 2		(+V _S) - 2	V	
Occurred Made Date than Date (OMDD)	$\Delta V_{CM} = \pm 0.5 \text{V}, V_S = \pm 2.5 \text{V} \text{ or 5V}$	107	130		-ID	
Common Mode Rejection Ratio (CMRR)	$\Delta V_{CM} = \pm 1V$, $V_S = \pm 18V$ or $36V$	109	125		dB	
Output Characteristics				•	•	
Output Voltage Swing from Rail (V _{OH})	R_{LOAD} = 32 Ω , V_S = ±2.5 V to ±5 V or V_S = 5 V to 10 V		0.72	1.1	V	
Output Voltage Swing from Rail (V _{OL})			0.51	0.64	V	
Output Voltage Swing from Rail (V _{OH})	D 4000		1.1	1.6	V	
Output Voltage Swing from Rail (VoL)	$R_{LOAD} = 100\Omega$		0.8	1	V	
Peak AC Output Current (2)	SFDR ≤ -65dBc, f = 100kHz, V_{OUT} = 0.4 V_{P-P} , R_{LOAD} = 1Ω, V_{S} = ±2.25V or 4.5V SFDR ≤ -55dBc, f = 100kHz, V_{OUT} = 20 V_{P-P} ,		200		mA	
	$R_{LOAD} = 32\Omega$, $V_S = \pm 12V$ or 24V		310			
Dynamic Performance						
-3dB Gain-Bandwidth Product	$V_{OUT} = 0.1V_{P-P}$		22		MHz	
0.1dB Flatness	$V_{OUT} = 0.1V_{P-P}$		1.6		MHz	
Large-Signal Bandwidth	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$		23		MHz	
Large-Oighai Dandwidth	$V_{OUT} = 2V_{P-P}, V_S = \pm 18V \text{ or } 36V$		12		IVII IZ	
	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$		27		V/µs	
Slew Rate (SR)	$V_{OUT} = 1V_{P-P}, V_S = \pm 2.5V \text{ or } 5V$		33			
Siew Mate (SIM)	$V_{OUT} = 4V_{P-P}, V_S = \pm 5V \text{ or } 10V$		49		ν/μ3	
	$V_{OUT} = 4V_{P-P}, V_S = \pm 12V \text{ or } 24V$		34			
Noise/Distortion Performance						
	$f_C = 100kHz$, $V_{OUT} = 1V_{P-P}$, $G = +2$, $V_S = \pm 2.25V$ or 4.5V		-95			
Distortion (Worst Harmonia)	$f_C = 100kHz, V_{OUT} = 2V_{P-P}, G = +2, V_S = \pm 2.5V \text{ or } 5V$		-93		dBc	
Distortion (Worst Harmonic)	$f_C = 100kHz, V_{OUT} = 6V_{P-P}, G = +2, V_S = \pm 5V \text{ or } 10V$		-88			
	$f_C = 100kHz$, $V_{OUT} = 20V_{P-P}$, $G = +5$, $V_S = \pm 12V$ or $24V$		-52			
Input Voltage Noise Density (en)	f = 100kHz		3.5		nV/√Hz	
Input Current Noise Density (in)	f = 100kHz		4	1	pA/√Hz	



ELECTRICAL CHARACTERISTICS (continued)

(At T_A = +25°C, V_S = 4.5V to 36V or V_S = ±2.25V to ±18V, G = +1, R_{LOAD} = 32 Ω , V_{CM} = V_{OUT} = $V_S/2$, unless otherwise noted.) (1)

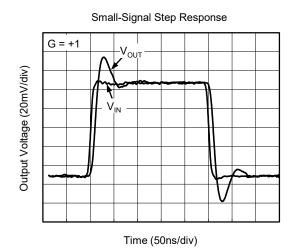
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply					
Operating Voltage Range (Dual Supply)		±2.25		±18	V
Supply Current/Amplifier (I _Q)			9	11.5	mA
Power Supply Rejection Ratio (PSRR)	$\Delta V_S = \pm 0.5 V$	100	115		dB
Audio Performance					
	$f = 1kHz$, $V_{OUT} = 0.5V_{P-P}$, $V_S = \pm 2.25V$ or 4.5V,		0.0006		%
	BW = 80kHz		-104		dB
Tatal Haymania Distortion + Naise (THD+N)	$f = 1kHz$, $V_{OUT} = 1V_{P.P.}$, $V_S = \pm 2.5V$ or 5V, BW = 80kHz		0.0003		%
	1 - 1KHZ, V _{OUT} - 1V _{P-P} , V _S - ±2.3V OI 3V, BVV - 60KHZ		-110		dB
Total Harmonic Distortion + Noise (THD+N)	f - 4kH= \		0.00005		%
	$f = 1kHz$, $V_{OUT} = 6V_{P-P}$, $V_S = \pm 5V$ or 10V, BW = $80kHz$		-126		dB
	f = 4 d = 1/2 = 21/2 1/2 = 1/2 2/2 D = 20 d =		0.00005		%
	$f = 1 \text{kHz}, V_{\text{OUT}} = 3 V_{\text{RMS}}, V_{\text{S}} = \pm 12 \text{V} \text{ or } 24 \text{V}, \text{BW} = 80 \text{kHz}$		-126		dB

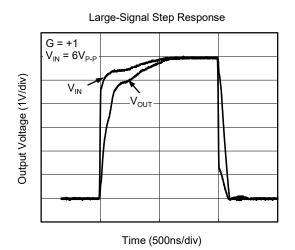
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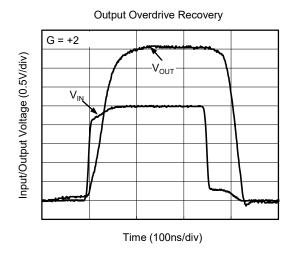
- 1. Unity-gain can promote characterization. It is recommended to use a gain of 2 or greater to improve stability.
- 2. Peak AC output current is only for normal AC operation, and continuous DC operation is invalid.

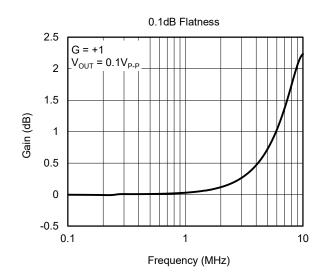
TYPICAL PERFORMANCE CHARACTERISTICS

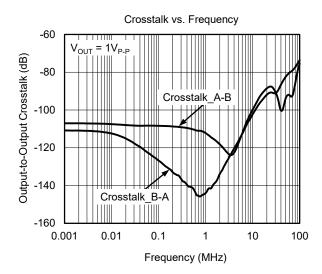
At T_A = +25°C, V_S = ±5V, R_{LOAD} = 32 Ω , unless otherwise noted.

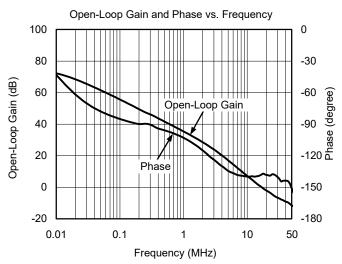






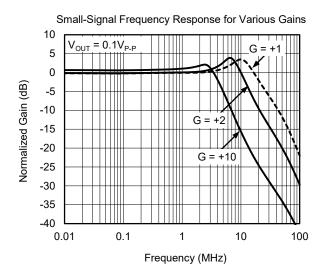


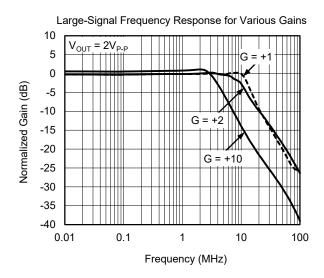


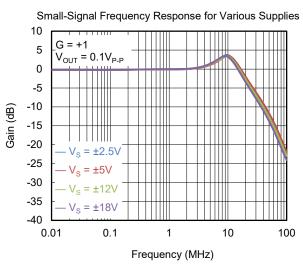


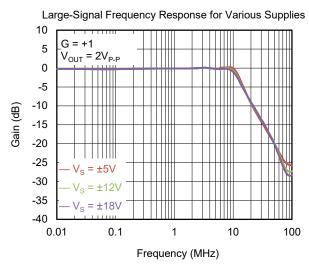
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

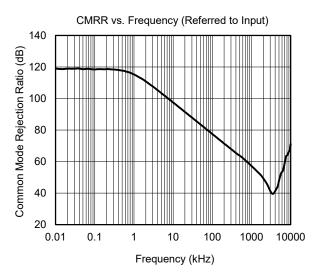
At $T_A = +25$ °C, $V_S = \pm 5V$, $R_{LOAD} = 32\Omega$, unless otherwise noted.

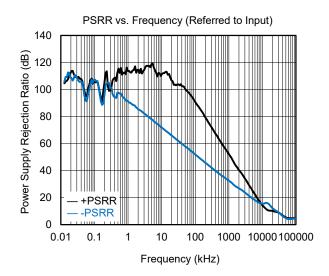






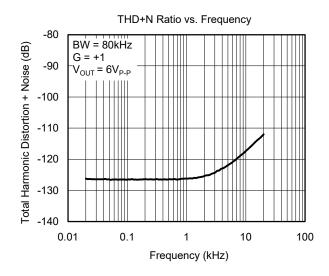


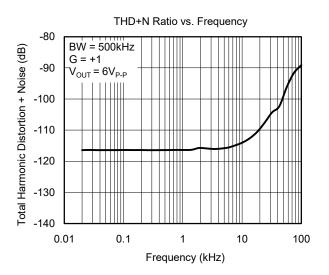


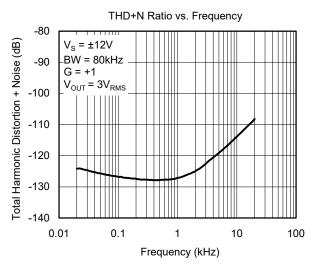


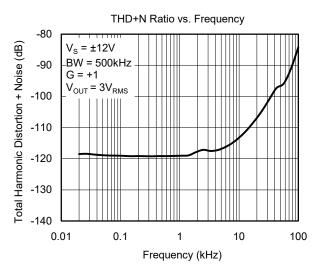
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

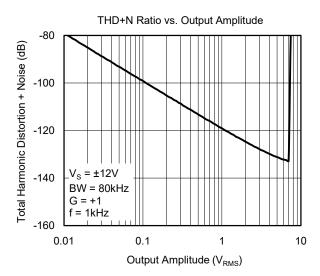
At T_A = +25°C, V_S = ±5V, R_{LOAD} = 32 Ω , unless otherwise noted.











APPLICATION INFORMATION

The SGM8262-2 is a dual, low noise, high speed operational amplifier with voltage feedback function. The output swing is rail-to-rail with heavy loads. The SGM8262-2 is optimized for high voltage operation from $\pm 2.25 \text{V}$ to $\pm 18 \text{V}$ dual supplies.

Power Supply and Decoupling

The supported voltage of the power supply for SGM8262-2 is from $\pm 2.25 V$ to $\pm 18 V$. Also, the customer should ensure that the source of the power supply is low noise and well-regulated. The power supply should be decoupled suitably. The power supply ripple and power dissipation can be decreased dramatically by using low ESR capacitor. The multilayer ceramic capacitors (MLCCs) are good choices for decoupling. A 0.1µF MLCC capacitor should be placed as close as possible (0.125 inches) to the power supply pin of the SGM8262-2. For decoupling the low-frequency signals, $10\mu F$ to $22\mu F$ tantalum capacitors should be taken into account so that it can convey the current for large and fast signal changes.

Layout

A good PCB layout is important for the performance of SGM8262-2 in high speed applications in order to prevent the parasitic effects from the board. The PCB should have a low impedance loop (or ground) to the power supply. Removing the GND planes for all of the layers of the PCB board can simply reduce the stray capacitors. Also, the PCB traces should be placed as short as possible in order to reduce parasitic inductance and capacitance. The resistors or loads should be placed as close as possible to the terminals of the SGM8262-2. The input traces of the SGM8262-2 should be placed away from the output trace to minimize coupling (crosstalk).

If the SGM8262-2 is used for differential driver, the customers should guarantee the symmetrical layout to obtain better output performance. If the trace for the differential signal is long, please make sure that place the two differential traces as close as possible, or twist them together in order to reduce the inductive loop. The above method can enhance the anti-interference ability for RF signal by reducing the radiated energy. It is recommended to use strip line for the signal trace which is longer than 1 inch.

High Speed, Ultra-Low Noise, Rail-to-Rail Output, High Output Current Amplifier

SGM8262-2

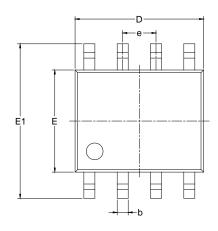
REVISION HISTORY

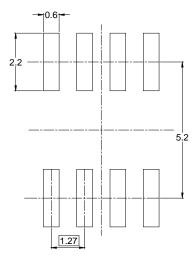
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

MARCH 2023 - REV.A to REV.A.1	Page
Updated Typical Performance Characteristics section	7
Changes from Original (JUNE 2017) to REV.A	Page
Changed from product preview to production data	All

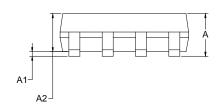


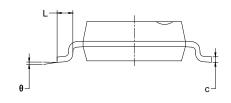
PACKAGE OUTLINE DIMENSIONS SOIC-8





RECOMMENDED LAND PATTERN (Unit: mm)



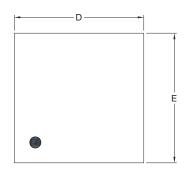


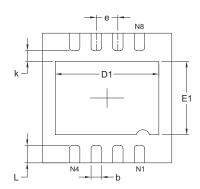
Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.27 BSC		0.050	BSC	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

- Body dimensions do not include mode flash or protrusion.
 This drawing is subject to change without notice.



PACKAGE OUTLINE DIMENSIONS TDFN-3×3-8BL

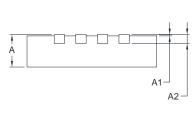




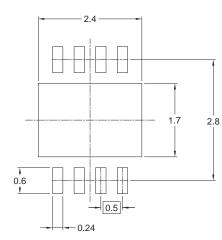
TOP VIEW







SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

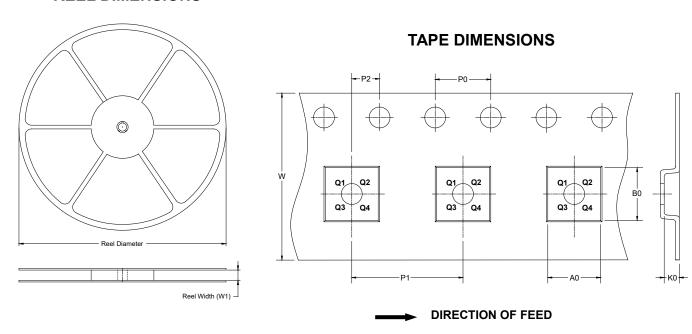
Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203	0.203 REF		REF	
D	2.900	3.100	0.114	0.122	
D1	2.300	2.500	0.091	0.098	
Е	2.900	3.100	0.114	0.122	
E1	1.600	1.800	0.063	0.071	
k	0.200	MIN	0.008	MIN	
b	b 0.180		0.007	0.012	
е	0.500	0.500 TYP		TYP	
L	0.300	0.500	0.012	0.020	

NOTE: This drawing is subject to change without notice.



TAPE AND REEL INFORMATION

REEL DIMENSIONS

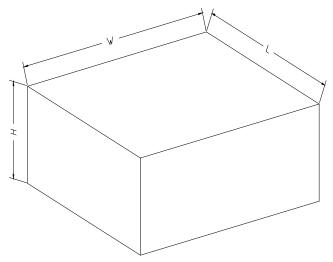


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant	
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1	
TDFN-3×3-8BL	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1	DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13"	386	280	370	5	